

# **MOSFET**

## OptiMOS™ 6 Power-Transistor, 200 V

### **Features**

- N-channel, normal level
- Low on-resistance R<sub>DS(on)</sub>
   Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   Very low reverse recovery charge (Q<sub>rr</sub>)
- 175°C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020
- · 100% avalanche tested

### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

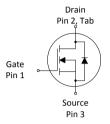
Table 1 Key performance parameters

Parameter	Value	Unit	
$V_{\mathrm{DS}}$	200	V	
$R_{\mathrm{DS(on),max}}$	9.5	mΩ	
I <sub>D</sub>	116	А	
$Q_{ m oss}$	168	nC	
$Q_{G}$	53	nC	
Q <sub>rr</sub> (1000A/μs)	307	nC	



D<sup>2</sup>PAK







Part number	Package	Marking	Related links
IPB095N20NM6	PG-TO263-3	095N20N6	-

## Public

# OptiMOS™ 6 Power-Transistor, 200 V IPB095N20NM6



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# OptiMOS™ 6 Power-Transistor, 200 V IPB095N20NM6



# 1 Maximum ratings

at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			Linit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition	
				116		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C	
0 1)	,		-	82		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C	
Continuous drain current 1)	l <sub>D</sub>	-		86	Α	$V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C	
				13		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	464	Α	<i>T</i> <sub>A</sub> =25 °C	
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	373	mJ	$I_{\rm D}$ =56 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	$V_{GS}$	-20	-	20	V	-	
Power dissipation	$P_{\rm tot}$	-		300	١٨/	<i>T</i> <sub>C</sub> =25 °C	
			-	3.8	W	$T_A$ =25 °C, $R_{thJA}$ =40 °C/W <sup>2)</sup>	
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	_	175	°C	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

## 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Syllibot	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	$R_{thJC}$		0.39	0.5		
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>5)</sup>	$R_{thJA}$	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	$R_{ m thJA}$		-	62		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 6 Power-Transistor, 200 V IPB095N20NM6



# 3 Electrical characteristics

at  $T_i$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Davamatav	Cymphol	Values			1154	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	200	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.7	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 186 \mu{\rm A}$	
Zana anto maltana dunin amusust	],	-	0.1	1		$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	
Zero gate voltage drain current	$I_{\rm DSS}$		10	100	μΑ	V <sub>DS</sub> =160 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	$I_{\rm GSS}$	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V	
During and the second	D <sub>D</sub>		7.2	8.7	mΩ	$V_{\rm GS}$ =15 V, $I_{\rm D}$ =62 A	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	_	8.0	9.5	11122	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =62 A	
Gate resistance	$R_{G}$	-	3.6	-	Ω	-	
Transconductance <sup>6)</sup>	$g_{fs}$	23	45	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=62 \text{ A}$	

<sup>6)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			l lni+	Note / Test condition
raiailletei	Symbol	Min.	Тур.	Max.		Note / Test condition
Input capacitance <sup>7)</sup>	C <sub>iss</sub>		4200	5500		
Output capacitance 7)	Coss	]-	660	860	рF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =100 V, <i>f</i> =1 MHz
Reverse transfer capacitance 7)	C <sub>rss</sub>		24	42		
Turn-on delay time	$t_{\sf d(on)}$		15			
Rise time	t <sub>r</sub>		30		ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =31 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$		28	]-		
Fall time	t <sub>f</sub>		11			

<sup>7)</sup> Defined by design. Not subject to production test.

# OptiMOS™ 6 Power-Transistor, 200 V IPB095N20NM6



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note / Test condition
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Gate to source charge	$Q_{gs}$		27	-	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	15.4 - nC 10.4 15.6 nC	15.4	-	nC	
Gate to drain charge <sup>9)</sup>	$Q_{ m gd}$		  // =100 \/ / =21 \/ \/ =0 to 10 \/			
Switching charge	$Q_{sw}$	]	22	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =31 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>9)</sup>	$Q_{ m g}$		53	66	nC	
Gate plateau voltage	$V_{ m plateau}$		6.5	-	V	
Output charge <sup>9)</sup>	$Q_{\rm oss}$	-	168	223	nC	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V

<sup>8)</sup> See "Gate charge waveforms" for parameter definition

### Table 7 Reverse diode

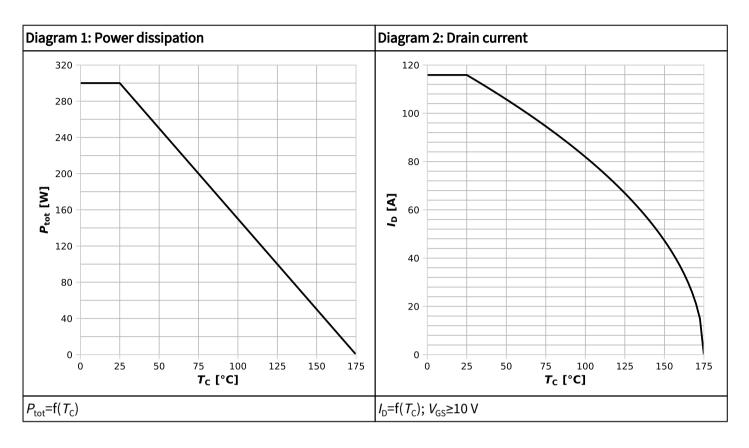
Parameter	Symbol	Values			Linit	Note / Test condition	
raiailletei	Symbol	Min.	Тур.	Max.	Oille	Note / Test condition	
Diode continuous forward current	I <sub>S</sub>			116		<i>T<sub>c</sub></i> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	_	_	464	А	1 <sub>C</sub> -25 C	
Diode forward voltage	$V_{\rm SD}$	-	0.89	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =62 A, $T_{\rm j}$ =25 °C	
Reverse recovery time	$t_{\rm rr}$		58	-	ns	1/_100\/	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	-	78	156	nC	$V_{\rm R}$ =100 V, $I_{\rm F}$ =31 A, d $i_{\rm F}$ /d $t$ =100 A/ $\mu$ s	
Reverse recovery time	$t_{\rm rr}$		31	-	ns	1/_100\/	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	-	307	614	nC	$V_{\rm R}$ =100 V, $I_{\rm F}$ =31 A, d $i_{\rm F}$ /d $t$ =1000 A/ $\mu$ :	

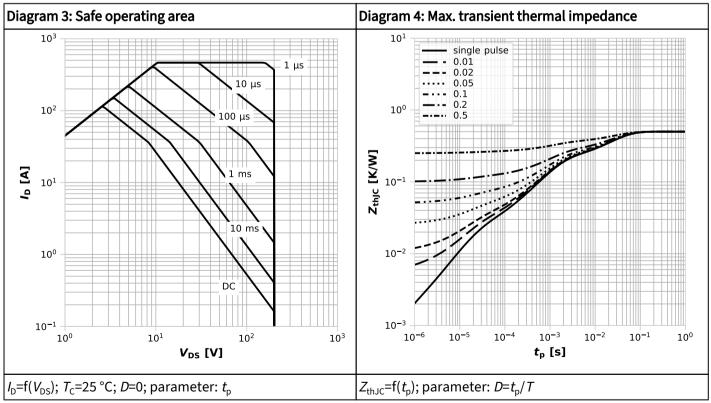
<sup>10)</sup> Defined by design. Not subject to production test.

<sup>9)</sup> Defined by design. Not subject to production test.

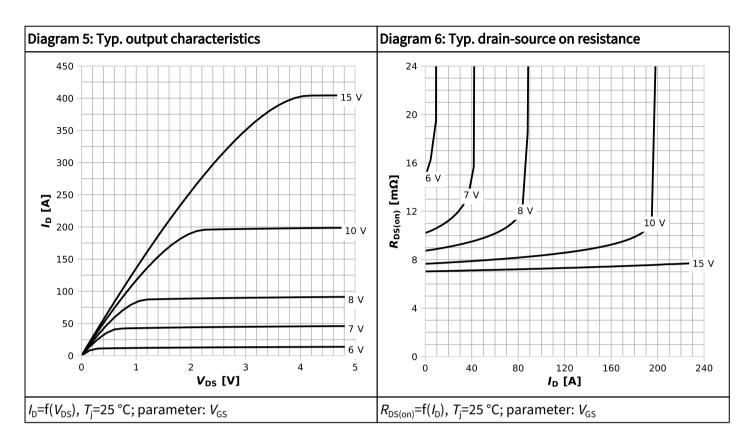


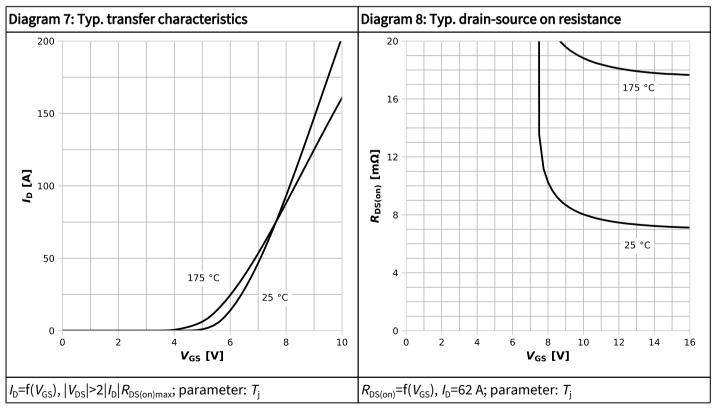
# 4 Electrical characteristics diagrams



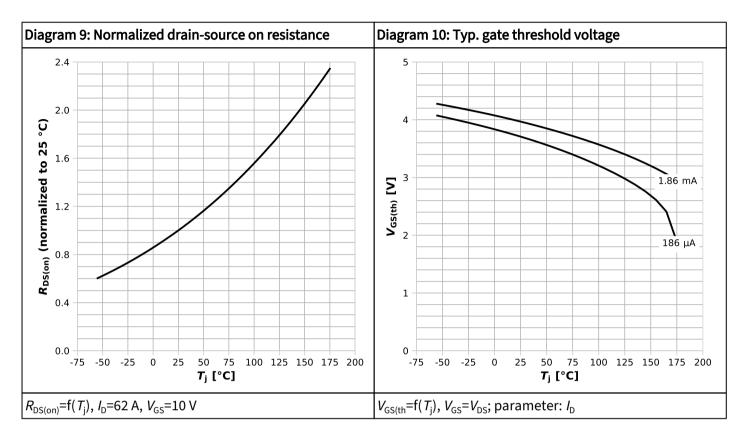


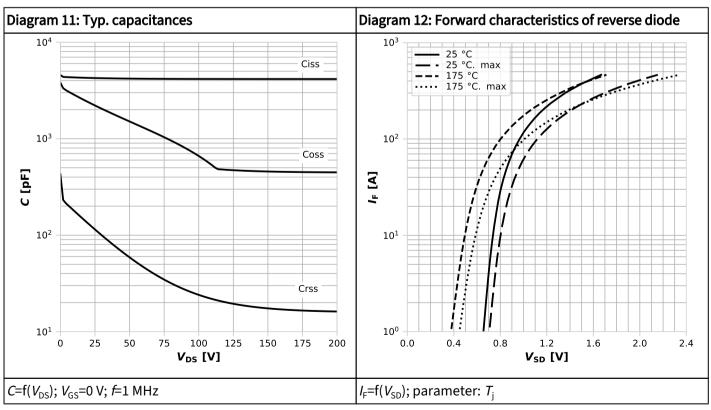




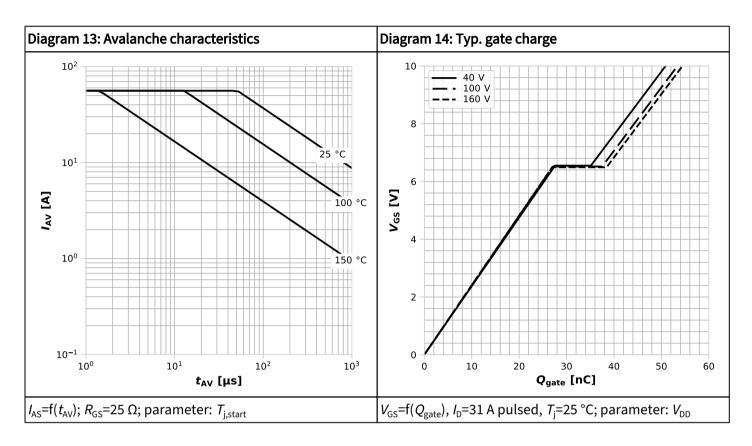


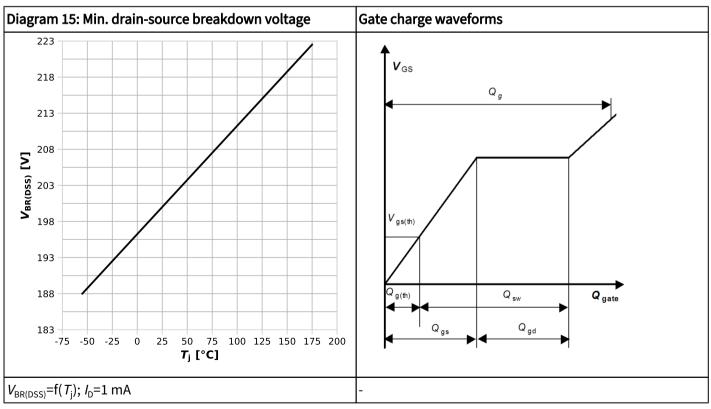






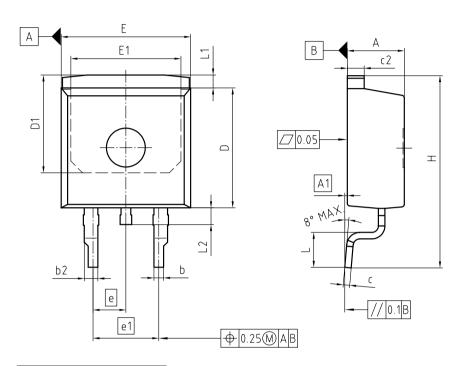








# 5 Package outlines



PACKAGE - GROUP NUMBER:	PG-TO20	63-3-U01				
DIMENSIONS	MILLIMETERS					
DIMENSIONS	MIN.	MAX.				
Α	4.30	4.50				
A1	0.00	0.10				
b	0.65	0.85				
b2	0.95	1.15				
С	0.40	0.60				
c2	1.17	1.37				
D	9.05	9.45				
D1	7.45	7.65				
E	9.80	10.20				
E1	8.40	8.60				
е	2.54					
e1	5.08					
N	2					
Н	14.60	15.90				
L	2.40	3.00				
L1	0.70	1.30				
L2	1.00	1.60				

Figure 1 Outline PG-TO263-3, dimensions in mm

## Public

# OptiMOS™ 6 Power-Transistor, 200 V IPB095N20NM6



# **Revision history**

IPB095N20NM6

## Revision 2025-03-25, Rev. 1.0

Previous revisions

Revision	Date	Subjects (major changes since last revision)
1.0	2025-03-25	Release of final datasheet

#### **Public**

# OptiMOS™ 6 Power-Transistor, 200 V IPB095N20NM6



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